TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHC273F,TC74VHC273FT,TC74VHC273FK

Octal D-Type Flip-Flop with Clear

The TC74VHC273 is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

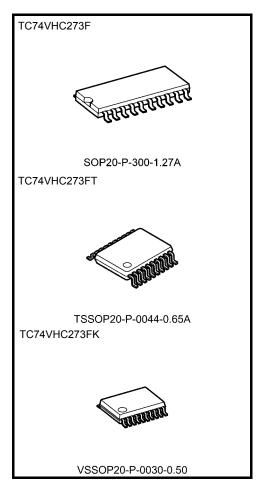
Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

When the $\overline{\text{CLR}}$ input is held "L", the Q outputs are at a low logic level independent of the other inputs.

An input protection circuit ensures that 0 to 5.5~V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5~V to 3~V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

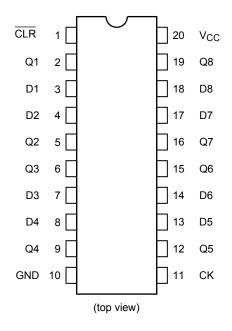
- High speed: $f_{max} = 165 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: $V_{CC \text{ (opr)}} = 2 \text{ to } 5.5 \text{ V}$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS273



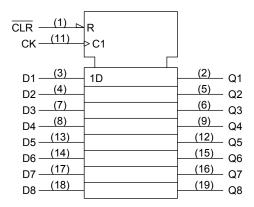
Weight

SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Pin Assignment



IEC Logic Symbol

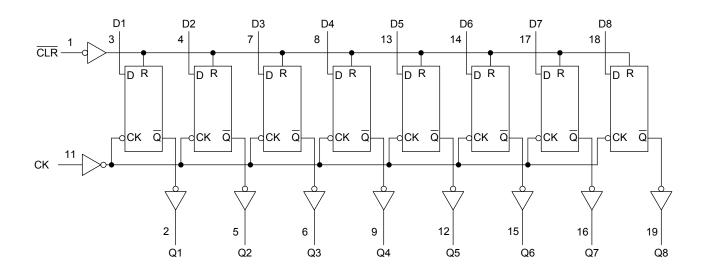


Truth Table

	Inputs		Output	Function		
CLR	D	CK	Q	Function		
L	Х	Х	L	Clear		
Н	L		L	_		
Н	Н		Н	_		
Н	Х	\neg	Q_n	No Change		

X: Don't care

System Diagram





Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	−0.5 to 7.0	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	l _{IK}	-20	mA
Output diode current	I _{ok}	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±75	mA
Power dissipation	PD	180	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2.0 to 5.5	V
Input voltage	V _{IN}	0 to 5.5	٧
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 ($V_{CC} = 3.3 \pm 0.3 \text{ V}$) 0 to 20 ($V_{CC} = 5 \pm 0.5 \text{ V}$)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

3



Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition $V_{CC}\left(V\right)$		Ta = 25°C			Ta = -40 to 85°C		Unit	
	·			V _{CC} (V)	Min	Тур.	Max	Min	Max	
High-level input		_		2.0	1.50	_	_	1.50	_	٧
voltage	V _{IH}			3.0 to 5.5	V _{CC} × 0.7	_	_	V _{CC} × 0.7	_	
Low-level input		_		2.0	_	_	0.50	_	0.50	
voltage	V _{IL}			3.0 to 5.5	_	_	V _{CC} × 0.3	_	V _{CC} × 0.3	V
	V _{ОН}			2.0	1.9	2.0	_	1.9	_	
		V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -50 \mu A$	3.0	2.9	3.0	_	2.9	_	٧
High-level output voltage				4.5	4.4	4.5		4.4	_	
Ü			I _{OH} = -4 mA	3.0	2.58	_	_	2.48	_	
			$I_{OH} = -8 \text{ mA}$	4.5	3.94			3.80	_	
	V _{OL}	V _{IN} = V _{IH} or V _{IL}		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 50 \mu A$	3.0	_	0.0	0.1		0.1	
Low-level output voltage				4.5	—	0.0	0.1	_	0.1	V
			I _{OL} = 4 mA	3.0	_	_	0.36		0.44	
			I _{OL} = 8 mA	4.5	_		0.36	_	0.44	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_		±0.1		±1.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or	GND	5.5	_	_	4.0	_	40.0	μА

Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C	Unit
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width (CK)	t _{w (L)}		3.3 ± 0.3	_	5.5	6.5	ns
Minimum pulse width (CK)	t _{w (H)}	_	5.0 ± 0.5	_	5.0	5.0	
Minimum pulse width (CLR)	t _{w (L)}	_	3.3 ± 0.3	_	5.0	6.0	ns
Willimum puise width (CER)			5.0 ± 0.5	_	5.0	5.0	
Minimum set-up time	ts	_	3.3 ± 0.3	_	5.5	6.5	ns
Millimum set-up time			5.0 ± 0.5	_	4.5	4.5	
Minimum hold time	t _h		3.3 ± 0.3	_	1.0	1.0	20
Willimum noid time			5.0 ± 0.5	_	1.0	1.0	ns
Minimum removal time (CLR)	+	_	3.3 ± 0.3	_	2.5	2.5	ne
Willimum removal tille (CLR)	t _{rem}		5.0 ± 0.5	_	2.0	2.0	ns



AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Tes	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	,		V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	
			3.3 ± 0.3	15	_	8.7	13.6	1.0	16.0	ns
Propagation delay time	t_{pLH}			50	_	11.2	17.1	1.0	19.5	
(CK-Q)	t_{pHL}	_	5.0 ± 0.5	15	_	5.8	9.0	1.0	10.5	115
, ,			5.0 ± 0.5	50	_	7.3	11.0	1.0	12.5	
			3.3 ± 0.3	15	_	8.9	13.6	1.0	16.0	ns ns
Propagation delay time	t _{pHL}	_		50	_	11.4	17.1	1.0	19.5	
(CLR -Q)			5.0 ± 0.5	15	_	5.2	8.5	1.0	10.0	
				50	_	6.7	10.5	1.0	12.0	
	f _{max}	_	3.3 ± 0.3	15	75	120	_	65	_	- MHz
Maximum clock				50	50	75	_	45	_	
frequency			5.0 ± 0.5	15	120	165	_	100	_	
				50	80	110	_	70	_	
Output to output akow	t _{osLH}	(Note 1)	3.3 ± 0.3	50	_	_	1.5	_	1.5	no
Output to output skew	t _{osHL}	(Note 1)	5.0 ± 0.5	50	_	_	1.0	_	1.0	ns
Input capacitance	C _{IN}		_		_	4	10	_	10	pF
Power dissipation capacitance	C_{PD}			(Note 2)	_	31	_	_	_	pF

Note 1: Parameter guaranteed by design.

 $t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|$

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

And the total $C_{\mbox{\scriptsize PD}}$ when n pcs.of flip flop operate can be gained by the following equation:

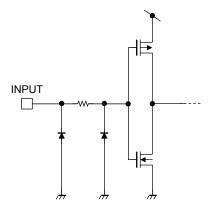
 C_{PD} (total) = 22 + 9·n

Noise Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	Ţ		Ta = 25°C	
Characteristics	Symbol		V _{CC} (V)	Тур.	Max	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	0.5	0.8	٧
Quiet output minimum dynamic V _{OL}	V_{OLV}	C _L = 50 pF	5.0	-0.5	-0.8	>
Minimum high level dynamic input voltage	V_{IHD}	C _L = 50 pF	5.0		3.5	>
Maximum low level dynamic input voltage	V _{ILD}	C _L = 50 pF	5.0	_	1.5	٧



Input Equivalent Circuit

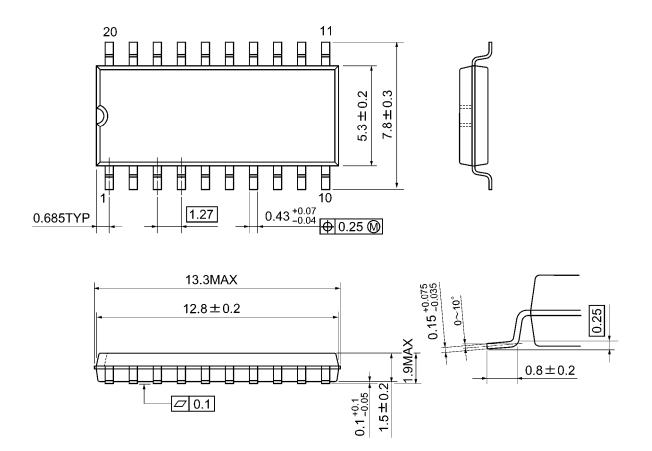


6



Package Dimensions

SOP20-P-300-1.27A Unit: mm

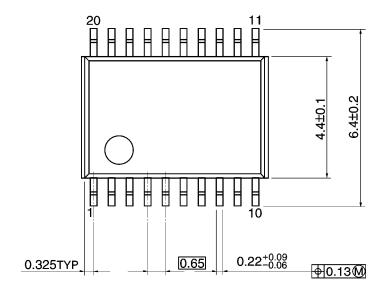


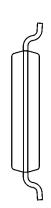
Weight: 0.22 g (typ.)

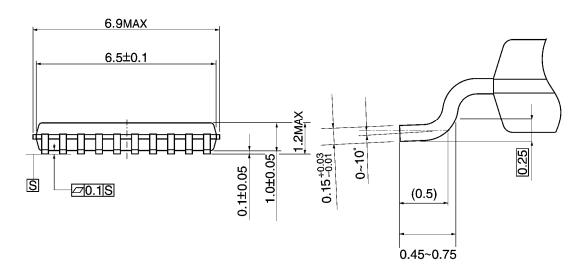
Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm





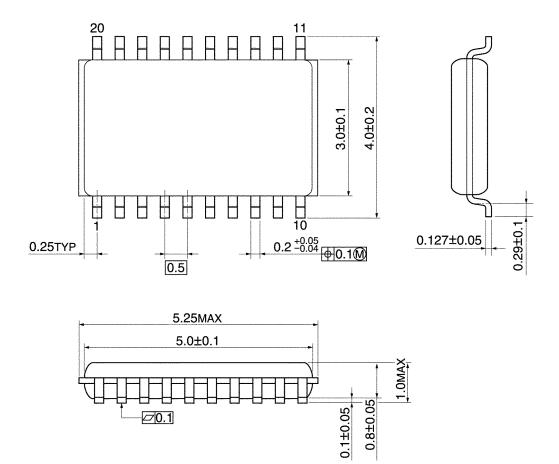


8

Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



9

Weight: 0.03 g (typ.)

270.1

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10